Crystal Oscillator (SPXO)

· Package size (7.0 mm × 5.0 mm × 1.3 mm)

- Fundamental mode SPXO
- · Output: CMOS

· Reference weight Typ.147 mg

[1] Product Number / Product Name / Marking

(1-1) Product Number / Ordering Code

X1G0044810008xx

Last 2 digits $code(\mathbf{xx})$ defines Quantity.

The standard is "00", 1 000 pcs/Reel.

(1-2) Product Name / Model Name

SG7050CAN 20.000000 MHz TJGA

[2] Operating Range

| Parameter | Symbol | Specifications | | | Unit | Conditions | |
|-----------------------------|-----------------|----------------|------|------|-------|------------|--|
| Falameter | Symbol | Min. | Тур. | Max. | Offic | Conditions | |
| Supply voltage | V _{CC} | 1.60 | - | 3.63 | V | - | |
| Supply voltage | GND | 0 | - | 0 | V | - | |
| Operating temperature range | T_use | -40 | - | +85 | °C | - | |
| CMOS load condition | L_CMOS | - | - | 15 | pF | - | |

[3] Frequency Characteristics

(Unless stated otherwise [3] Operating Range)

| Parameter | Symbol | | Specification | S | Unit | Conditions | |
|------------------------|--------|------|---------------|------|-------------------|--------------------|--|
| Farameter | Symbol | Min. | Тур. | Max. | Unit | Conditions | |
| Output frequency | fo | - | 20.000000 | - | MHz | - | |
| Frequency tolerance *1 | f_tol | -50 | - | +50 | ×10 ⁻⁶ | T_use | |
| Frequency aging | f_age | -3 | - | +3 | ×10 ⁻⁶ | +25 °C, First year | |

*1 Frequency tolerance includes initial frequency tolerance, temperature variation, supply voltage change and load drift.

[4] Electrical Characteristics

(Unless stated otherwise [3] Operating Range)

| Doromotor | Parameter Symbol | | Specification | าร | Unit | Conditions | |
|--------------------------|------------------|----------|---------------|----------|------|--|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Conditions | |
| Start-up time | t_str | - | - | 3.0 | ms | t = 0 at 90 % Vcc | |
| Current consumption | I _{CC} | - | - | 1.8 | mA | No load condition, Vcc = 3.3 V | |
| Stand-by current | I_std | - | - | 2.7 | μA | <u>ST</u> = GND, Vcc = 3.3 V | |
| Output voltage | V _{OH} | 90 % Vcc | - | - | V | Іон = -4 mA @Vcc = 3.3 V | |
| | V _{OL} | - | - | 10 % Vcc | V | IoL = 4 mA @Vcc = 3.3 V | |
| Rise time | tr | - | - | 3.5 | ns | 20 % Vcc to 80 % Vcc Level, L_CMOS = 15 pF, Vcc = 1.8 V ± 10 % | |
| Fall time | tf | - | - | 3.5 | ns | 80 % Vcc to 20 % Vcc Level, L_CMOS = 15 pF, Vcc = 1.8 V ± 10 % | |
| Symmetry | SYM | 45 | - | 55 | % | 50 % Vcc Level, L_CMOS ≤ 15 pF | |
| Input voltage | V _{IH} | 80 % Vcc | - | - | V | ST terminal | |
| Input voltage | V _{IL} | - | - | 20 % Vcc | V | ST terminal | |
| Output disable time (ST) | tstp_st | - | - | 100 | ns | \overline{ST} terminal HIGH \rightarrow LOW | |
| Output enable time (ST) | tsta_st | - | - | 3 | ms | \overline{ST} terminal LOW \rightarrow HIGH | |

[For other general specifications, please refer to the attached Full Data Sheet below]

Crystal oscillator: SG2016/3225/5032/7050CAN & SG-210STF

Features

- Crystal oscillator (SPXO)
- Frequency:
- 20 standard frequencies (4 MHz to 72 MHz)

CMOS

1.6 V to 3.63 V

-20 °C to +70 °C

-40 °C to +105 °C

Output:

- Supply voltage:
- Operating temperature:

Applications

- IoT, Wearable device
- Data center, Storage
- Medical, Industrial automation

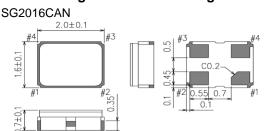
Description

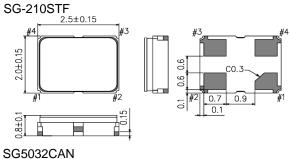
RoH9 Complian SG2016CAN SG-210STF (2.0 × 1.6 mm) (2.5 × 2.0 mm) SG5032CAN (5.0 × 3.2 mm) SG3225CAN (3.2 × 2.5 mm) SG7050CAN (7.0 × 5.0 mm)

Epson's SGxxxxCAN & SG-210STF are Simple Packaged Crystal Oscillator (SPXO) series with CMOS output. These SPXO's are ideal for variety of applications from IoT, wearables, medical, industrial automation, etc. These SPXO have low current consumption, wide operating voltage from 1.6 V to 3.63 V and wide operating temperature range from -40 °C to 85 °C, in addition operation up to 105 °C is available.

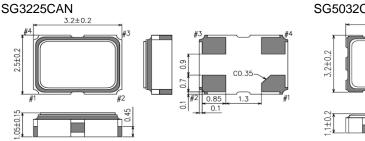
These SPXO's are available in five different package size from 2.0 × 1.6 mm to 7.0 × 5.0 mm and available in standard pin out's.

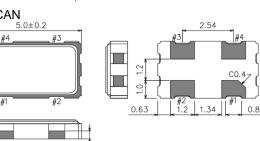
Outline Drawing and Terminal Assignment





0.45

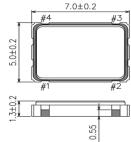


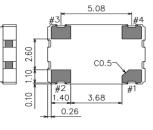


SG7050CAN

2.5±0.2

05±0.





Terminal Assignment

| Pin # | Connection | Function | | | | |
|-------|-----------------|---------------------------|---|---|--|--|
| | | ST terminal | | | | |
| #1 | 5T | ST function | Osc. Circuit | Output | | |
| #1 | 51 | "H" or OPEN | Oscillation | Specified frequency: Enable | | |
| | | "L" | Oscillation stop | High impedance: Disable | | |
| #2 | GND | GND terminal | | | | |
| #3 | Ουτ | Output terminal | | | | |
| #4 | V _{cc} | V _{cc} terminal | | | | |
| | #1 #2 #3 | #1 ST #2 GND #3 OUT | #1 ST terminal #1 ST #2 GND #3 OUT ST terminal "H" or OPEN "L" "L" "L" "L" "L" "L" "L" "L" "L" "L | #1 ST ST terminal #1 ST ST function Osc. Circuit "H" or OPEN Oscillation "L" Oscillation stop #2 GND GND terminal Output terminal | | |

[1] Product Name / Product Number

(1-1) SG2016CAN

(1) Product Name (Standard Form)

<u>SG2016 C AN</u> <u>25.000000MHz</u> <u>T J H A</u> ① ② ③ ④ ⑤⑦

①Model ②Output (C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature ⑦Internal identification code ("A" is default)

| (4)Supply voltage Refer to Figure 1 | ⁽⁵⁾ Frequency tolerance / ⁽⁶⁾ Operating temperature |
|-------------------------------------|---|
| T 1.8 V to 3.3 V Typ. | DB ±25 × 10 ⁻⁶ / -20 °C to +70 °C |
| K 2.5 V to 3.3 V Typ. | JG ±50 × 10 ⁻⁶ / -40 °C to +85 °C |
| *Figure 1 is on the next page | JH ±50 × 10 ⁻⁶ / -40 °C to +105 °C |

| | Frequency tolerance / Operating temperature | | | | |
|-----------------|---|------------------------|------------------------|--|--|
| Fragueney [MHz] | DB | JG | JH | | |
| Frequency [MHz] | ±25 × 10 ⁻⁶ | ±50 × 10 ⁻⁶ | ±50 × 10 ⁻⁶ | | |
| | -20 °C to +70 °C | -40 °C to +85 °C | -40 °C to +105 °C | | |
| 4 | - | X1G004801003000 | X1G004801004900 | | |
| 8 | - | X1G004801004500 | X1G004801004600 | | |
| 10 | - | X1G004801002900 | X1G004801002700 | | |
| 12 | X1G004801005000 | X1G004801000700 | X1G004801005100 | | |
| 12.288 | X1G004801005200 | X1G004801004400 | X1G004801005300 | | |
| 14.7456 | - | X1G004801005400 | X1G004801005500 | | |
| 16 | - | X1G004801001400 | X1G004801005600 | | |
| 20 | X1G004801005700 | X1G004801005800 | X1G004801001800 | | |
| 24 | X1G004801005900 | X1G004801000200 | X1G004801004000 | | |
| 24.576 | - | X1G004801006000 | X1G004801003100 | | |
| 25 | X1G004801002400 | X1G004801001200 | X1G004801003500 | | |
| 26 | - | X1G004801000300 | X1G004801003900 | | |
| 27 | - | X1G004801006100 | X1G004801002100 | | |
| 32 | - | X1G004801006200 | X1G004801006300 | | |
| 33.33 | - | X1G004801006400 | X1G004801006500 | | |
| 33.3333 | - | X1G004801002600 | X1G004801006600 | | |
| 40 | - | X1G004801006700 | X1G004801003600 | | |
| 48 | X1G004801006800 | X1G004801002000 | X1G004801006900 | | |
| 50 | X1G004801007000 | X1G004801001300 | X1G004801002800 | | |
| 72 | X1G004801007100 | X1G004801007200 | X1G004801007300 | | |

(1-2) SG-210STF

(1) Product Name (Standard Form)

<u>SG-210 STF</u> <u>25.000000MHz</u> Y ① ②③ ④ ⑤

①Model ②Function (S:Standby) ③Supply voltage

(4) Frequency (5) Frequency tolerance / Operating temperature

| (3)S | upply | volta | ge F | Refer to | o Figure | 1 |
|------|-------|--------|------|----------|----------|---|
| Т | 1.8 \ | / to 3 | .3 V | Тур. | | |

| 1.0 | v io 0.0 | v | Typ. |
|-----|-----------|----|------------------|
| | *Figure 1 | is | on the next page |

| ୬Fr | Prequency tolerance / Operating temperature | | | | | |
|-----|---|--|--|--|--|--|
| S | ±25 × 10 ⁻⁶ / -20 °C to +70 °C | | | | | |
| L | ±50 × 10 ⁻⁶ / -40 °C to +85 °C | | | | | |
| Y | ±50 × 10 ⁻⁶ / -40 °C to +105 °C | | | | | |

| | Frequency tolerance / Operating temperature | | | | |
|-----------------|---|------------------------|------------------------|--|--|
| | S | L | Y | | |
| Frequency [MHz] | ±25 × 10 ⁻⁶ | ±50 × 10 ⁻⁶ | ±50 × 10 ⁻⁶ | | |
| | -20 °C to +70 °C | -40 °C to +85 °C | -40 °C to +105 °C | | |
| 4 | - | X1G004171000900 | X1G004171029900 | | |
| 8 | - | X1G004171001500 | X1G004171006900 | | |
| 10 | - | X1G004171001600 | X1G004171036500 | | |
| 12 | X1G004171016300 | X1G004171001800 | X1G004171028000 | | |
| 12.288 | X1G004171006100 | X1G004171001900 | X1G004171036600 | | |
| 14.7456 | - | X1G004171002500 | X1G004171036700 | | |
| 16 | - | X1G004171002700 | X1G004171015400 | | |
| 20 | X1G004171021800 | X1G004171002900 | X1G004171023800 | | |
| 24 | X1G004171015600 | X1G004171003100 | X1G004171019700 | | |
| 24.576 | - | X1G004171003200 | X1G004171036800 | | |
| 25 | X1G004171007700 | X1G004171003300 | X1G004171005900 | | |
| 26 | - | X1G004171003400 | X1G004171024400 | | |
| 27 | - | X1G004171003500 | X1G004171025000 | | |
| 32 | - | X1G004171004000 | X1G004171012700 | | |
| 33.33 | - | X1G004171011900 | X1G004171030000 | | |
| 33.3333 | - | X1G004171012000 | X1G004171007500 | | |
| 40 | - | X1G004171004500 | X1G004171020600 | | |
| 48 | X1G004171007800 | X1G004171004600 | X1G004171036900 | | |
| 50 | X1G004171007900 | X1G004171004700 | X1G004171012600 | | |
| 72 | X1G004171037000 | X1G004171012400 | X1G004171037100 | | |

(1-3) SG3225CAN

(1) Product Name (Standard Form)

<u>SG3225 C AN</u> <u>25.000000MHz</u> <u>T J H A</u> (1) 2) <u>3</u> <u>4</u>567

①Model ②Output (C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature ⑦Internal identification code ("A" is default)

| 4 Supply voltage Refer to Figure 1 | | (5)F | requency tolerance / $^{\textcircled{6}}$ Operating temperature |
|------------------------------------|-------------------------------|------|---|
| Т | 1.8 V to 3.3 V Typ. | DB | ±25 × 10 ⁻⁶ / -20 °C to +70 °C |
| Κ | 2.5 V to 3.3 V Typ. | JG | ±50 × 10 ⁻⁶ / -40 °C to +85 °C |
| | *Figure 1 is on the next page | JH | ±50 × 10 ⁻⁶ / -40 °C to +105 °C |

| | Frequency | tolerance / Operating temperature | | |
|-----------------|------------------------|-----------------------------------|-------------------------|--|
| Frequency [MHz] | DB | JG | JH | |
| Frequency [MHz] | ±25 × 10 ⁻⁶ | ±50 × 10 ⁻⁶ | $\pm 50 \times 10^{-6}$ | |
| | -20 °C to +70 °C | -40 °C to +85 °C | -40 °C to +105 °C | |
| 4 | - | X1G005961001115 | X1G005961001215 | |
| 8 | - | X1G005961000415 | X1G005961001315 | |
| 10 | - | X1G005961000515 | X1G005961001415 | |
| 12 | X1G005961001515 | X1G005961000615 | X1G005961001615 | |
| 12.288 | X1G005961001715 | X1G005961001815 | X1G005961001915 | |
| 14.7456 | - | X1G005961002015 | X1G005961002115 | |
| 16 | - | X1G005961002215 | X1G005961002315 | |
| 20 | X1G005961002415 | X1G005961000715 | X1G005961002515 | |
| 24 | X1G005961002615 | X1G005961000115 | X1G005961002715 | |
| 24.576 | - | X1G005961000815 | X1G005961002815 | |
| 25 | X1G005961002915 | X1G005961000215 | X1G005961003015 | |
| 26 | - | X1G005961003115 | X1G005961003215 | |
| 27 | - | X1G005961003315 | X1G005961003415 | |
| 32 | - | X1G005961003515 | X1G005961003615 | |
| 33.33 | - | X1G005961003715 | X1G005961003815 | |
| 33.3333 | - | X1G005961003915 | X1G005961004015 | |
| 40 | - | X1G005961000915 | X1G005961004115 | |
| 48 | X1G005961004215 | X1G005961000315 | X1G005961004315 | |
| 50 | X1G005961004415 | X1G005961001015 | X1G005961004515 | |
| 72 | X1G005961004615 | X1G005961004715 | X1G005961004815 | |

(1-4) SG5032CAN

(1) Product Name (Standard Form)

<u>SG5032 C AN</u> <u>25.000000MHz</u> <u>T J H A</u> (1) (2) (3) (4) (6) (7)

①Model ②Output (C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature ⑦Internal identification code ("A" is default)

| 4 Supply voltage Refer to Figure 1 | ⁽⁵⁾ Frequer | ncy tolerance / $^{\textcircled{6}}$ Operating temperature |
|------------------------------------|------------------------|--|
| T 1.8 V to 3.3 V Typ. | DB ±25 > | < 10 ⁻⁶ / -20 ⁰C to +70 ⁰C |
| K 2.5 V to 3.3 V Typ. | JG ±50 > | < 10 ⁻⁶ / -40 ⁰C to +85 ⁰C |
| *Figure 1 is on the next page | JH ±50 > | < 10 ⁻⁶ / -40 ⁰C to +105 ⁰C |

| | Frequency tolerance / Operating temperature | | | | |
|-----------------|---|------------------------|------------------------|--|--|
| Frequency [MHz] | DB | JG | JH | | |
| | ±25 × 10 ⁻⁶ | ±50 × 10 ⁻⁶ | ±50 × 10 ⁻⁶ | | |
| | -20 °C to +70 °C | -40 °C to +85 °C | -40 °C to +105 °C | | |
| 4 | - | X1G004451003400 | X1G004451019600 | | |
| 8 | - | X1G004451002100 | X1G004451019700 | | |
| 10 | - | X1G004451001300 | X1G004451017800 | | |
| 12 | X1G004451019800 | X1G004451002800 | X1G004451019900 | | |
| 12.288 | X1G004451020000 | X1G004451000100 | X1G004451020100 | | |
| 14.7456 | - | X1G004451001900 | X1G004451020200 | | |
| 16 | - | X1G004451000200 | X1G004451020300 | | |
| 20 | X1G004451020400 | X1G004451001100 | X1G004451020500 | | |
| 24 | X1G004451017200 | X1G004451000300 | X1G004451020600 | | |
| 24.576 | - | X1G004451002900 | X1G004451020700 | | |
| 25 | X1G004451009700 | X1G004451000400 | X1G004451020800 | | |
| 26 | - | X1G004451008200 | X1G004451020900 | | |
| 27 | - | X1G004451000500 | X1G004451021000 | | |
| 32 | - | X1G004451001400 | X1G004451021100 | | |
| 33.33 | - | X1G004451021200 | X1G004451021300 | | |
| 33.3333 | - | X1G004451016700 | X1G004451021400 | | |
| 40 | - | X1G004451001200 | X1G004451021500 | | |
| 48 | X1G004451014900 | X1G004451000700 | X1G004451011200 | | |
| 50 | X1G004451011500 | X1G004451000800 | X1G004451003600 | | |
| 72 | X1G004451021600 | X1G004451021700 | X1G004451021800 | | |

(1-5) SG7050CAN

(1) Product Name (Standard Form)

<u>SG7050 CAN</u> <u>25.000000MHz</u> <u>T J H A</u> (1) <u>(2)</u> <u>(3)</u> <u>4</u>(5)6(7)

①Model ②Output (C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature ⑦Internal identification code ("A" is default)

| (4)SI | upply voltage Refer to Figure 1 | (5) _F | requency tolerance / ⁶ Operating temperature |
|-------|---------------------------------|------------------|---|
| Т | 1.8 V to 3.3 V Typ. | DB | ±25 × 10 ⁻⁶ / -20 °C to +70 °C |
| Κ | 2.5 V to 3.3 V Typ. | JG | ±50 × 10 ⁻⁶ / -40 °C to +85 °C |
| | *Figure 1 is on the next page | JH | ±50 × 10 ⁻⁶ / -40 °C to +105 °C |

| | Frequency tolerance / Operating temperature | | | |
|-----------------|---|------------------------|------------------------|--|
| Frequency [MHz] | DB | JG | JH | |
| | ±25 × 10 ⁻⁶ | ±50 × 10 ⁻⁶ | ±50 × 10 ⁻⁶ | |
| | -20 °C to +70 °C | -40 °C to +85 °C | -40 °C to +105 °C | |
| 4 | - | X1G004481005100 | X1G004481025200 | |
| 8 | - | X1G004481001400 | X1G004481025300 | |
| 10 | - | X1G004481000500 | X1G004481025400 | |
| 12 | X1G004481025500 | X1G004481000600 | X1G004481025600 | |
| 12.288 | X1G004481025700 | X1G004481000100 | X1G004481025800 | |
| 14.7456 | - | X1G004481002500 | X1G004481025900 | |
| 16 | - | X1G004481000700 | X1G004481026000 | |
| 20 | X1G004481012800 | X1G004481000800 | X1G004481026100 | |
| 24 | X1G004481002200 | X1G004481000200 | X1G004481026200 | |
| 24.576 | - | X1G004481001600 | X1G004481026300 | |
| 25 | X1G004481011600 | X1G004481000300 | X1G004481026400 | |
| 26 | - | X1G004481003500 | X1G004481026500 | |
| 27 | - | X1G004481000400 | X1G004481026600 | |
| 32 | - | X1G004481000900 | X1G004481026700 | |
| 33.33 | - | X1G004481017900 | X1G004481026800 | |
| 33.3333 | - | X1G004481003300 | X1G004481026900 | |
| 40 | - | X1G004481001500 | X1G004481027000 | |
| 48 | X1G004481022600 | X1G004481001100 | X1G004481027100 | |
| 50 | X1G004481011200 | X1G004481001200 | X1G004481016000 | |
| 72 | X1G004481027200 | X1G004481018300 | X1G004481027300 | |

[2] Absolute Maximum Ratings

| Parameter | Symbol | Symbol | | Unit | Conditions | |
|---------------------------|-----------------|--------|------|-----------------------|------------|----------------------|
| Falameter | Symbol | Min. | Тур. | Max. | Offic | Conditions |
| Maximum supply voltage | V _{CC} | -0.3 | - | 4 | V | |
| Input voltage | Vin | -0.3 | - | V _{CC} + 0.3 | V | ST terminal |
| Storage temperature range | Tota | -55 | - | +125 | °C | SG2016CAN, SG3225CAN |
| | T_stg | -40 | - | +125 | °C | All other |

[3] Operating Range

| Parameter | Symbol | Symbol Specification | | | Unit | Conditions |
|--|-----------------|----------------------|------|------|-------|--------------------------------------|
| Faiametei | Symbol | Min. | Тур. | Max. | Offic | Conditions |
| Supply voltage | | 1.6 | - | 3.63 | V | fo ≤ 50 MHz, T_use = +105 °C Max. |
| | V _{cc} | 1.71 | - | 3.63 | V | fo = 72 MHz, T_use = +85 °C Max. |
| | | 2.25 | - | 3.63 | V | fo = 72 MHz, T_use = +105 °C Max. |
| Supply voltage | GND | 0.0 | 0.0 | 0.0 | V | |
| | | -20 | +25 | +70 | °C | |
| Operating temperature range (Refer to Figure 1) | T_use | -40 | +25 | +85 | °C | |
| | | -40 | +25 | +105 | °C | |
| CMOS load condition | L_CMOS | - | - | 15 | pF | |

* Power supply startup time (0 %V_{CC} \rightarrow 90 %V_{CC}) should be more than 150 µs * A 0.01 µF to a 0.1 µF bypass capacitor should be connected between V_{CC} and GND pins located close to the device



Please note that Supply voltage range (V $_{\rm CC})$ depends on Output frequency(fo) and upper limit of Operating temperature(T_use Max.).

Figure 1: The upper limit of Operating temperature and the related conditions

[4] Frequency Characteristics

(Unless stated otherwise [3] Operating Range)

| Parameter | Symbol | Specification | | Unit | Conditions | |
|------------------------|--------|---|------|------|-------------------|--|
| Farameter | Symbol | Min. | Тур. | Max. | Onit | Conditions |
| Output frequency | fo | 4, 8, 10, 12, 12.288, 14.7456, 16, 20, 24, 24.576, 25, 26, 27, 32, 33.33, 33.3333, 40, 48, 50, 72 | | MHz | | |
| | f_tol | -25 | - | +25 | ×10 ⁻⁶ | T_use = -20 °C to +70 °C |
| Frequency tolerance *1 | | -50 | - | +50 | v10 ° | T_use = -40 °C to +105 °C T_use = -40 °C to +85 °C *2 |
| Frequency aging | f_age | -3 | | +3 | ×10 ⁻⁶ | T_use = +25 °C, First year |

*1 Frequency tolerance includes initial frequency tolerance, frequency / temperature characteristics, frequency / voltage coefficient, and frequency / load coefficient

*2 This temperature range is only for fo = 72 MHz

| 5] Electrical Characteristics | | | | (U | nless stated | otherwise [3] Operating Range |
|------------------------------------|-----------------|-----------------------|---------------|----------------------|--------------|--|
| Parameter | Symbol | | Specification | | Unit | Conditions |
| | Cymbol | Min. | Тур. | Max. | Onic | Conditions |
| Start-up time | t_str | - | - | 3 | ms | t = 0 at 90 %V _{CC} |
| Current consumption (No load) | | - | - | 1.5 | mA | 4 MHz ≤ fo ≤ 20 MHz |
| $V_{cc} = 1.8 \text{ V} \pm 10 \%$ | | - | - | 1.8 | mA | 20 MHz < fo ≤ 40 MHz |
| VCC = 1.0 V ± 10 /0 | | - | - | 2.1 | mA | 40 MHz < fo ≤ 50 MHz |
| $V_{CC} = 1.8 V \pm 5 \%$ | | - | - | 2.4 | mA | fo = 72 MHz |
| | | - | - | 1.6 | mA | 4 MHz ≤ fo ≤ 20 MHz |
| Current consumption (No load) | | - | - | 2.0 | mA | 20 MHz < fo ≤ 40 MHz |
| $V_{CC} = 2.5 \text{ V} \pm 10 \%$ | I _{CC} | - | - | 2.4 | mA | 40 MHz < fo ≤ 50 MHz |
| | | - | - | 2.8 | mA | fo = 72 MHz |
| | _ | - | - | 1.8 | mA | 4 MHz ≤ fo ≤ 20 MHz |
| Current consumption (No load) | | - | - | 2.2 | mA | 20 MHz < fo ≤ 40 MHz |
| $V_{CC} = 3.3 \text{ V} \pm 10 \%$ | | - | - | 2.6 | mA | 40 MHz < fo ≤ 50 MHz |
| | | - | - | 3.0 | mA | fo = 72 MHz |
| | | - | - | 2.1 | μA | $V_{CC} = 1.8 \text{ V} \pm 10 \% \text{ or} \pm 5 \%,$ $\overline{ST} = \text{GND}$ |
| Stand-by current | I_std | - | - | 2.5 | μA | V _{CC} = 2.5 V ± 10 %, ST = GND |
| | | - | - | 2.7 | μA | V _{CC} = 3.3 V ± 10 %, ST = GND |
| | V _{OH} | 90 % V _{CC} | - | - | V | Load current condition 1.8 V ± 10 % 2.5 V ± 10 % 3.3 V ± 10 % |
| | V _{OL} | - | - | 10 % V _{CC} | V | I _{OH} -1.5 mA -3 mA -4 mA I _{OL} 1.5 mA 3 mA 4 mA |
| Output voltage | V _{OH} | V _{CC} - 0.4 | - | - | V | Load current condition 1.8 V ± 10 % 2.5 V ± 10 % 3.3 V ± 10 % |
| | V _{OL} | - | - | 0.4 | V | I _{OH} -3 mA -4 mA -6 mA I _{OL} 3 mA 4 mA 6 mA |
| Symmetry | SYM | 45 | 50 | 55 | % | 50 % V _{CC} level, L_CMOS ≤ 15 pF |
| Rise time/Fall time | tr / tf | - | - | 3 | ns | $V_{CC} = 2.5 V \text{ or } 3.3 V \pm 10 \%$, 20 % V_{CC} to 80 % V_{CC} Level, L_CMOS = 15 pF |
| | u / u | - | - | 3.5 | ns | $V_{CC} = 1.8 V \pm 10 \% \text{ or } \pm 5 \%$, 20 % V_{CC} to 80 % V_{CC} Level, L_CMOS = 15 pF |
| | V _{IH} | 80 % Vcc | - | - | V | ST terminal |
| Input voltage | V _{IL} | - | - | 20 % Vcc | V | |
| Output disable time (ST) | tstp_st | - | - | 100 | ns | \overline{ST} terminal HIGH \rightarrow LOW |
| Output enable time (ST) | tsta_st | - | - | 3 | ms | \overline{ST} terminal LOW \rightarrow HIGH |

[6] Thermal resistance (For reference only)

| Parameter | Symbol | | Specification | | Unit | Conditions |
|----------------------|--------|------|---------------|------|------|------------|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Conditions |
| Junction temperature | Tj | - | - | +125 | °C | |
| | | - | 9.8 | - | °C/W | SG2016CAN |
| | | - | 15.2 | - | °C/W | SG-210STF |
| Junction to case | θјс | - | 23.1 | - | °C/W | SG3225CAN |
| | | - | 16.1 | - | °C/W | SG5032CAN |
| | | - | 28.0 | - | °C/W | SG7050CAN |
| | | - | 99.6 | - | °C/W | SG2016CAN |
| | | - | 91.9 | - | °C/W | SG-210STF |
| Junction to ambient | θja | - | 103.8 | - | °C/W | SG3225CAN |
| | | - | 82.5 | - | °C/W | SG5032CAN |
| | | - | 78.8 | - | °C/W | SG7050CAN |





* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference. The actual current consumption is the total of the current under the condition of no load and the current to drive the output load (fo x L_CMOS x V_{CC}). To reduce the current consumption, it is effective to use lower frequency, lower supply voltage and lower output load.

(7-3) Rise Time / Fall Time

fo = 20 MHz, Rise Time



* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

fo = 20 MHz, Fall Time



* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

(7-3) Rise Time / Fall Time [cont'd]

fo = 40 MHz, Rise Time



* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

fo = 40 MHz, Fall Time



* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

(7-3) Rise Time / Fall Time [cont'd]

fo = 72 MHz, Rise Time



* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference. There are some missing data in the graph. It is unmeasurable because of low amplitude under the condition of L_CMOS > 15 pF.

fo = 72 MHz, Fall Time





* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference. There are some missing data in the graph. It is unmeasurable because of low amplitude under the condition of

L_CMOS > 15 pF.

(7-4) Symmetry

fo = 20 MHz



fo = 40 MHz

50 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



fo = 72 MHz



(7-5) Output Voltage



fo = 40 MHz



fo = 72 MHz





Jitter (T use = +25 °C, V_{cc} = 3.3 V)

| Jiller (1_use = +25 °C, $V_{CC} = 3.3 V$) | | | | | | |
|--|---------|--|--|--|--|--|
| Total jitter (BER = 10 ⁻¹²) | 22.3 ps | | | | | |
| RMS jitter | 1.8 ps | | | | | |
| Peak to peak jitter | 16 ps | | | | | |

-120 Hase -140

> -160 -180

1

10

100

1k

10k

Offset frequency [Hz]

100k

1M

10M

100M



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(7-7) Output Waveform [cont'd] fo = 72 MHz V_{CC} = 2.5 V, L_CMOS = 15 pF, T_use = +25 °C V_{CC} = 3.3 V, L_CMOS = 15 pF, T_use = +25 $^\circ\text{C}$ 3.5 3.5 3 3 2.5 2 1.5 1.5 2.5 Output voltage [V] 2 1.5 1 0.5 0.5 0 0 Time [5 ns / div] Time [5 ns / div] V_{CC} = 1.8 V, L_CMOS = 15 pF, T_use = +25 °C 3.5 3 2.5 2 2.5 1.5 1.5 0.5 0 Time [5 ns / div]

[8] Test Circuit

(8-1) Waveform Observation



(8-2) Current Consumption Test



*Standby current test should be $\overline{ST} = GND$.

- (8-3) Condition
- (1) Oscilloscope

The bandwidth should be minimum 5 times wider than measurement frequency

The probe ground should be placed closely to the test point and the lead length should be as short as possible

- * It is recommended to use miniature socket. (Don't use earth lead.)
- (2) L_CMOS includes probe capacitance.

(3) A 0.01 μF to a 0.1 μF bypass capacitor should be connected between V $_{CC}$ and GND pins located close to the device

- (4) Use a current meter with a low internal impedance
- (5) Power Supply

Power supply startup time (0 $\%V_{CC} \rightarrow 90 \%V_{CC}$) should be more than 150 µs Power supply impedance should be as low as possible

(8-4) Timing Chart

(1) Output Waveform and Level



(2) Output Frequency Timing



(3) ST Function and Timing



- *1 The period from $\overline{ST} = V_{IL}$ to OUT = High impedance (Disable)
- *2 The period from \overline{ST} = $V_{I\!H}$ to OUT = Enable
- * Judge of starting output: $V_{0H} \ge 80 \ \text{W}_{CC}$, $V_{0L} \le 20 \ \text{W}_{VCC}$, fout is within fo $\pm 1 \ 000 \times 10^{-6}$ * \overline{ST} terminal voltage level should not exceed supply voltage when using \overline{ST} function.

Please note that ST rise time should not exceed supply voltage rise time at the start-up.

[9] Outline Drawing and Recommended Footprint (9-1) SG2016CAN



connected between V_{CC} and GND and placed

Reference Weight Typ.: 9.9 mg

Terminal Assignment

| Pin # | Connection | Function | | | | | | |
|-------|-----------------|--------------------------|--------------------------|-----------------------------|--|--|--|--|
| | | ST terminal | ŜT terminal | | | | | |
| #4 | ST | \overline{ST} function | Osc. Circuit | Output | | | | |
| #1 | #1 ST | "H" or OPEN | Oscillation | Specified frequency: Enable | | | | |
| | | "L" | Oscillation stop | High impedance: Disable | | | | |
| #2 | GND | GND terminal | | | | | | |
| #3 | OUT | Output terminal | | | | | | |
| #4 | V _{cc} | V _{cc} terminal | V _{CC} terminal | | | | | |

Marking



Units: mm

(9-2) SG-210STF



Reference Weight Typ.: 14 mg

Terminal Assignment

| | Pin # | Connection | Function | | | | | | |
|--|-------|-----------------|--------------------------|------------------|-----------------------------|--|--|--|--|
| | | | ST terminal | 5T terminal | | | | | |
| | #1 ST | ᅙᆍ | \overline{ST} function | Osc. Circuit | Output | | | | |
| | | 51 | "H" or OPEN | Oscillation | Specified frequency: Enable | | | | |
| | | | "L" | Oscillation stop | High impedance: Disable | | | | |
| | #2 | GND | GND terminal | | | | | | |
| | #3 | OUT | Output terminal | | | | | | |
| | #4 | V _{cc} | V _{cc} terminal | | | | | | |



Units: mm

(9-3) SG3225CAN



Reference Weight Typ.: 25 mg

Terminal Assignment

| ···. | | | | | |
|------|-------|-----------------|--------------------------|------------------|-----------------------------|
| | Pin # | Connection | Function | | |
| | #1 | ST | ST terminal | | |
| | | | \overline{ST} function | Osc. Circuit | Output |
| | | | "H" or OPEN | Oscillation | Specified frequency: Enable |
| | | | "L" | Oscillation stop | High impedance: Disable |
| | #2 | GND | GND terminal | | |
| | #3 | OUT | Output termina | I | |
| | #4 | V _{cc} | V _{cc} terminal | | |



SEIKO EPSON CORPORATION

Units: mm



Reference Weight Typ.: 52 mg

Terminal Assignment

| similar Assignment | | | | |
|--------------------|-----------------|--------------------------|------------------|-----------------------------|
| Pin # | Connection | Function | | |
| #1 | ST | ST terminal | | |
| | | \overline{ST} function | Osc. Circuit | Output |
| | | "H" or OPEN | Oscillation | Specified frequency: Enable |
| | | "L" | Oscillation stop | High impedance: Disable |
| #2 | GND | GND terminal | | |
| #3 | Ουτ | Output terminal | | |
| #4 | V _{cc} | V _{cc} terminal | | |

| Symbol | E25. 000 | Frequency [MHz] |
|--------------------|----------|-----------------------|
| Location of Pin #1 | OCAN361S | Production lot number |
| | | |
| Model | | |

(9-5) SG7050CAN



5.08 #3 09 C0.5 1.40 3.68 1.40 0.26Terminal coating : Au plating

For stable operation, it is recommended that 0.01 μF to 0.1 μF bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 147 mg

Terminal Assignment

| CII | chillian Assignment | | | | |
|-----|---------------------|-----------------|--------------------------|------------------|-----------------------------|
| | Pin # | Connection | Function | | |
| | #1 | ST | ST terminal | | |
| | | | \overline{ST} function | Osc. Circuit | Output |
| | | | "H" or OPEN | Oscillation | Specified frequency: Enable |
| | | | "L" | Oscillation stop | High impedance: Disable |
| | #2 | GND | GND terminal | | |
| | #3 | OUT | Output termina | I | |
| | #4 | V _{cc} | V _{cc} terminal | | |

| Symbol | E25.000 | Frequency [MHz] |
|--------------------|----------|-----------------------|
| Location of Pin #1 | OCAN361S | Production lot number |
| Model | | |

[10] Moisture Sensitivity Level

| Parameter | Specification | Conditions |
|-----------|---------------|------------------------|
| MSL | LEVEL 1 | IPC/JEDEC J-STD-020D.1 |

[11] Reflow Profiles

IPC/JEDEC J-STD-020D.1



[12] Packing Information

(12-1) SG2016CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G004801xxxx \underline{xx}) are a code that defines the packing quantity. The standard is "00" for a 3 000 pcs/Reel.

(2) Taping Specification

Subject to EIA-481, IEC-60286 and JIS C0806

- 1) Tape Dimensions
 - Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

Units: mm



2) Reel Dimensions Center Material: PS (Polystyrene)

Reel Material: PS (Polystyrene)



Units: mm

3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

(12-2) SG-210STF

(1) Packing Quantity

The last two digits of the Product Number (X1G004171xxxx<u>xx</u>) are a code that defines the packing quantity. The standard is "00" for a 3 000 pcs/Reel.

(2) Taping Specification

Subject to EIA-481, IEC-60286 and JIS C0806

- 1) Tape Dimensions
 - Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

10P: 40.0±0.1 1.15±0.1 .75±0.1 2.0±0.1 +0.1 0.25 ± 0.05 Φ1.5 -0 4.0±0.1 .5±0.1 8.0±0.2 Epsor Epson 840 +0.1 4.0±0.1 Top tap <u>Φ1</u>.0-0 User direction of feed

2) Reel Dimensions

Center Material: PS (Polystyrene) Reel Material: PS (Polystyrene)



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

Units: mm

Units: mm

(12-3) SG3225CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G005961xxxx \underline{xx}) are a code that defines the packing quantity. The standard is "15" for a 2 000 pcs/Reel.

(2) Taping Specification

Subject to EIA-481, IEC-60286 and JIS C0806

- 1) Tape Dimensions
 - Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

(12-4) SG5032CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G004451xxxx \underline{xx}) are a code that defines the packing quantity. The standard is "00" for a 1 000 pcs/Reel.

(2) Taping Specification

Subject to EIA-481, IEC-60286 and JIS C0806

- 1) Tape Dimensions
 - Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

1.4±0.1 10P: 40±0.1 1.75±0.1 2.0±0.1 +0.1 Φ1.5 -0.0 0.3±0.05 4.0±0.1 ¢ ¢ ¢ φ φ 5.5±0.1 12.0±0.2 oEpson 0 Epson 5.4±0.³ +0.1 Φ1.5 -0.0 8.0±0.1 Тор Таре 3.5±0.1 User direction of feed

2) Reel Dimensions

Center Material: PS (Polystyrene) Reel Material: PS (Polystyrene)

Units: mm



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

Units: mm

(12-5) SG7050CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G004481xxxx \underline{xx}) are a code that defines the packing quantity. The standard is "00" for a 1 000 pcs/Reel.

(2) Taping Specification

Subject to EIA-481, IEC-60286 and JIS C0806

- 1) Tape Dimensions
 - Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

1.75±0.1 2.0±0.1 10P: 40.0±0.15 +0.1 Φ1.5 -0 2.0±0.1 0.3±0.05 4.0±0.1 0 7.5±0.1 16.0±0.2 oEpson Epson t 7.4±0. +0.1 8.0±0.1 5.1±0.1 Top tape Φ1.55-0 User direction of feed

2) Reel Dimensions

Center Material: PS (Polystyrene) Reel Material: PS (Polystyrene)

Units: mm

Units: mm



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

[13] Handling Precautions

Prior to using this product, please carefully read the section entitled "Precautions" on our Web site (https://www5.epsondevice.com/en/information/#precaution) for instructions on how to handle and use the product properly to ensure optimal performance of the product in your equipment. Before using the product under any conditions other than those specified therein,

please consult with us to verify and confirm that the performance of the product will not be negatively affected by use under such conditions.

In addition to the foregoing precautions, in order to avoid the deteriorating performance of the product, we strongly recommend that you DO NOT use the product under ANY of the following conditions:

- (1) Do not expose this product to excessive mechanical shock or vibration.
- (2) This product can be damaged by mechanical shock during the soldering process depending on the equipment used, process conditions, and any impact forces experienced. Always follow appropriate procedures, particularly when changing the assembly process in any way and be sure to follow applicable process qualification standards before starting production.
- (3) These devices are sensitive to ESD, use appropriate precautions during handling, assembly, test, shipment, and installation.
- (4) The use of ultrasonic technology for cleaning, bonding, etc. can damage the Xtal unit inside this product.
- Please carefully check for this consideration before using ultrasonic equipment for volume production with this product.(5) Noise and ripple on the power supply may have undesirable affects on operation and cause degradation of phase noise
- characteristics. Evaluate the operation of this device with appropriate power supplies carefully before use.
 (6) When applying power, ensure that the supply voltage increases monotonically for proper operation.
 On power down, do not reapply power until the supplies, bypass capacitors, and any bulk capacitors are complete
- On power down, do not reapply power until the supplies, bypass capacitors, and any bulk capacitors are completely discharged since that may cause the unit to malfunction.
- (7) Aging specifications are estimated from environmental reliability tests and expected frequency variation over time. They do not provide a guarantee of aging over the product lifecycle.
- (8) The metal cap on top of the device is directly connected to the GND terminal. Take necessary precautions to prevent any conductor not at ground potential from contacting the cap as that could cause a short circuit to GND.
- (9) Do not route any signal lines, supply voltage lines, or GND lines underneath the area where the oscillators are mounted including any internal layers and on the opposite side of the PCB. To avoid any issues due to interference of other signal lines, please take care not to place signal lines near the product as this may have an adverse affect on the performance of the product.
- (10) A bypass capacitor of the recommended value(s) must be connected between the V_{CC} and GND terminals of the product. Whenever possible, mount the capacitor(s) on the same side of the PCB and as close to the product as possible to keep the routing traces short.
- (11) Power supply connections to V_{CC} and GND pins should be routed as thick as possible while keeping the high frequency impedance low in order to get the best performance.
- (12) The use of a filter or similar element in series with the power supply connections to protect from electromagnetic radiation noise may increase the high frequency impedance of the power supply line and may cause the oscillator to not operate properly. Please verify the design to ensure sufficient operational margin prior to use.
- (13) Keep PCB routing from the output terminal(s) to the load as short as possible for best performance.
- (14) The Enable (ST) input terminal is high impedance and so susceptible to noise. Connect it to a low impedance source when used and when not used it is recommended to connect it to Vcc for active high inputs and GND for active low inputs.
- (15) Do not short the output to GND as that will damage the product. Always use with an appropriate load resistor connected.
- (16) This product should be reflowed no more than 3 times.
 If rework is needed after reflow, please correct it with a soldering iron with the tip set for a temperature of +350 °C or less and only contact each terminal once and for no more than 5 seconds.
 If this product is mounted on the bottom of the board during a reflow please check that it soldered down properly afterwards.

| [Availability of mounting con | ditions] |
|--|---|
| Reflow on the board | Avallable |
| Reflow under the board | The parts may fall. Please judge whether it is possible to implement. |
| Soldering pot/bath (Dip soldering system, Flow soldering system) | Not Avallable |
| Soldering iron | Avallable |

- (17) Product failures during the warranty period only apply when the product is used according to the recommended operating conditions described in the specifications. Products that have been opened for analysis or damaged will not be covered. It is recommended to store and use in normal temperature and humidity environments described in the specifications to ensure frequency accuracy and prevent moisture condensation. If the product is stored for more than one year, please confirm the pin solderability prior to use.
- (18) If the oscillation circuit is exposed to condensation, the frequency may change or oscillation may stop. Do not use in any conditions where condensation occurs.
- (19) Do not store or use the product in an environment where it can be exposed to chemical substances that are corrosive to metal or plastics such as salt water, organic solvents, chemical gasses, etc. Do not use the product when it is exposed to sunlight, dust, corrosive gasses, or other materials for long periods of time.
- (20) When using water-soluble solder flux make sure to completely remove the flux residue after soldering. Pay particular attention when the residues contain active halogens which will negatively affect the product and its performance.
- (21) Terminals on the side of the product are internally connected to the IC, be careful not to cause short-circuits or reduce the insulation resistance of them in any way.
- (22) Should any customer use the product in any manner contrary to the precautions and/or advice herein, such use shall be done at the customer's own risk.

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At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard. All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

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|--|-----------|
| Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive (Contains Pb in sealing glass, high melting temperature type solder or other) | |

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